

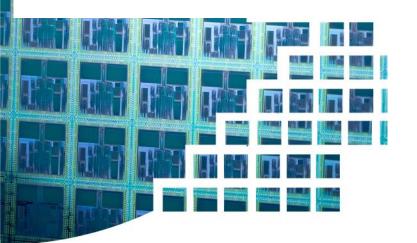


## CHALLENGE OF HIGH POWER LPP-EUV SOURCE WITH LONG COLLECTOR MIRROR LIFETIME FOR SEMICONDUCTOR HVM

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Gigaphoton Inc. Hiratsuka facility: 3-25-1 Shinomiya Hiratsuka Kanagawa, 254-8567, JAPAN

#### **Agenda**

- Introduction
  - Gigaphoton Business update
- EUV Research & Development History
- Experiment A: >330W Power Challenge of EUV Source
  - 1 CO2 Laser Power Upgrade
  - 2 Beam Uniformity Upgrade at Plasma Point
  - ③ Optimization of Plasma Parameters
- **Experiment B:** 
  - Long-term Test and Challenge for Long-life Mirror and Availability
    - 4 Lifetime Extension of Collector Mirror
- Summary & Acknowledgement



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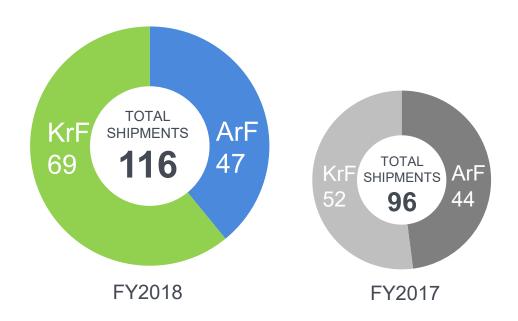
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#### 2Q2019 Business Highlights - DUV

#### **DUV Business**

- GPI recorded to ship 116 unit shipment as 51% M/S in FY2018 (Apr., 2018 Mar., 2019)
- Stronger KrF demand driven by 3D NAND device transitioning
- Released G45K as higher power model to the market in 1Q2019



#### Products Lineup for Tomorrow



#### **G45K**

248nm wavelength 4 kHz max repetition 40-50W output

20% module life\* improvement

#### **DUV Lithography**



#### GT45A

193nm wavelength 4~6kHz repetition 45W-90W output

**Utilizing same platform with ArFi** 

#### ArFi



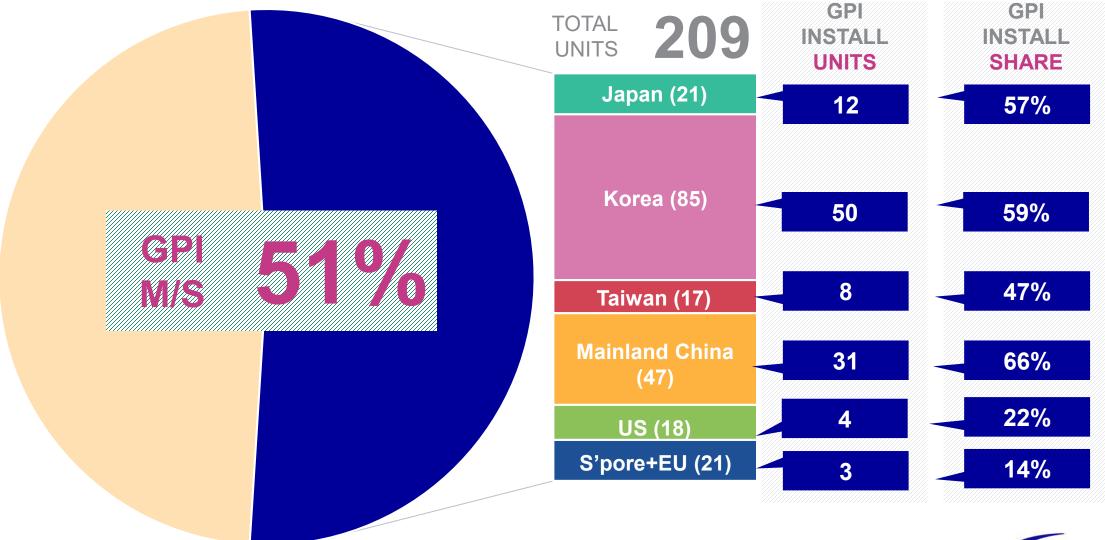
#### GT65A

193nm wavelength 6kHz max repetition 60-120W output

30% module life\* improvement

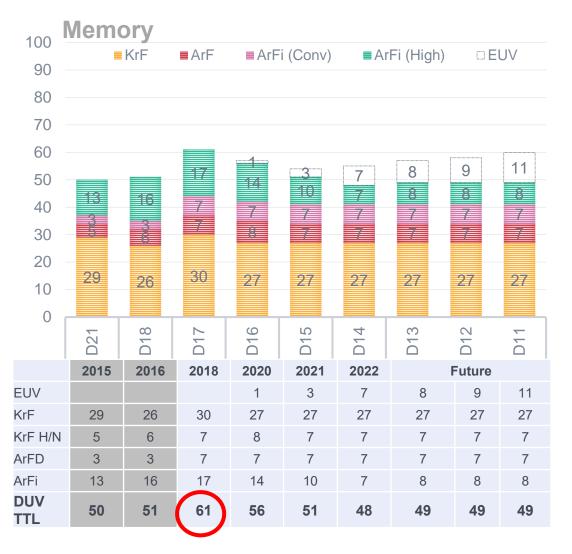


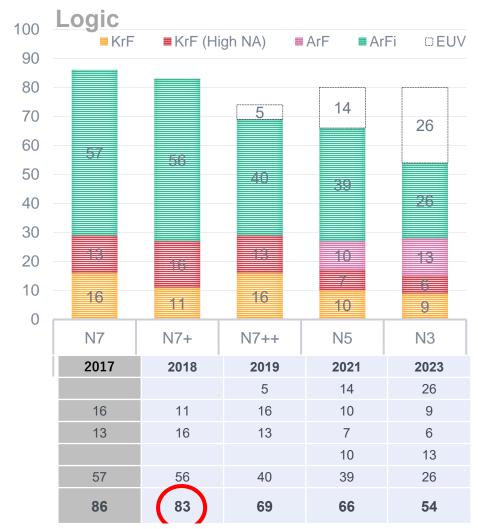
## CY2018 Light Source Projected Install Share Analysis



#### DUV Layers would be decreased after EUV HVM

- CY2018 is the peak of DUV adoption in HVM.
- CY2020-21 will be the Drastic Rump up of EUV at real HVM line.







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### **EUV Research & Development History**

Study Apparatus **EUV & Photo** Material by EIDEC



year **2002**-2008

2009

2010

2011 2012

2013 | 2014 | 2015 | 2016

2017 2018

2019

**EUVA** 

NEDO (Matching Fund/



**GIGAPHOTON (LPP)** 

USHIO (DPP)

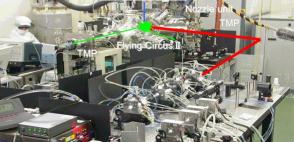


KOMATSU (TIC, MTC)

ETS-1

ETS-2

Proto#2



MOPA YAG laser system

**Magnetic Mitigation** 

Proto#1

Pilot#1

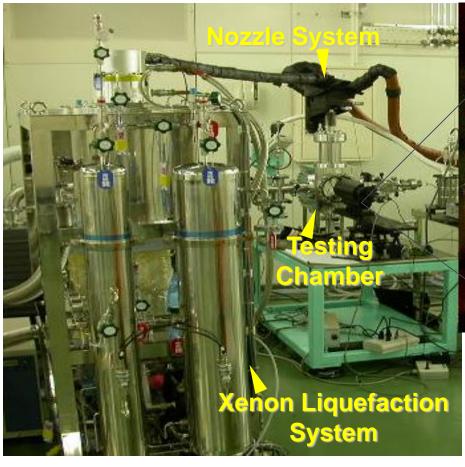






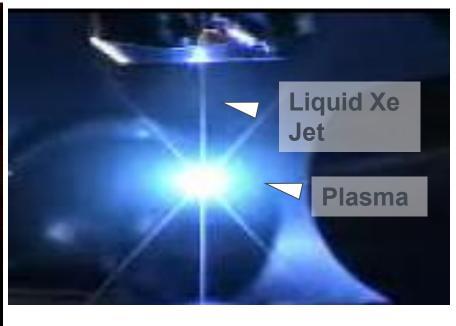
Xe +YAG Laser Sn +CO2 Laser

■ Start with Liquid Xe Jet target experiment with YAG laser driver



Nozzie

Liquid Xe
Jet



Xe Jet

Velocity :30m/s

Stability  $\sigma$ : 10 $\mu$ m @10mm

**Xe Jet and Plasma** 

Xe Temperature: 160K - 190K

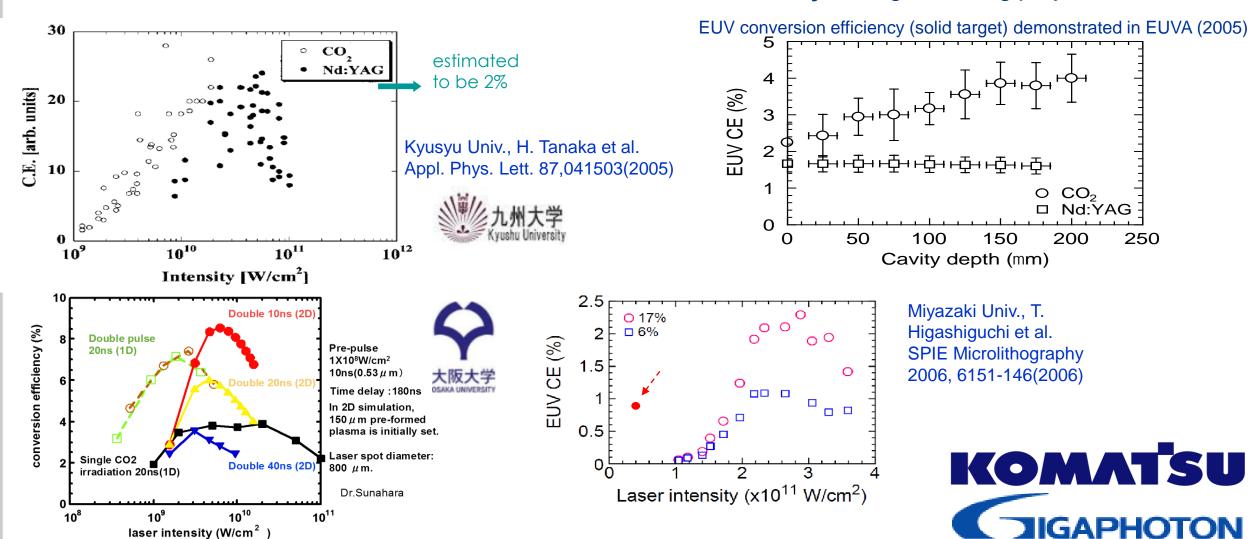
Xe Pressure:

<5MPa

**Liquid Xenon Jet System** 

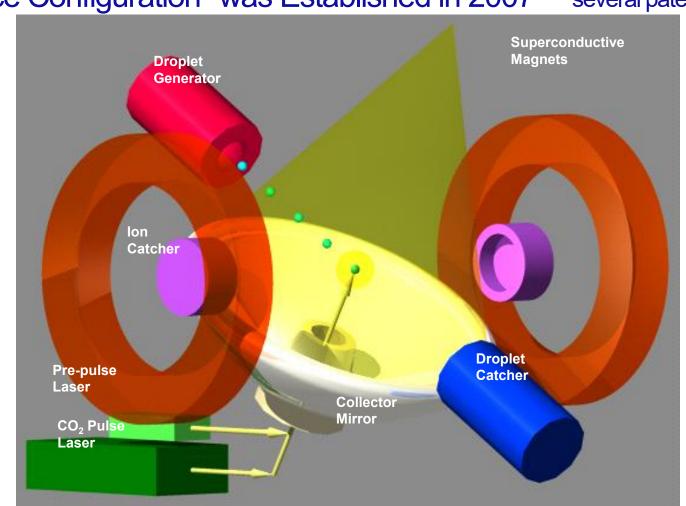


We found out Tin + CO2 laser could be around 8% efficiency through Leading project & EUVA.

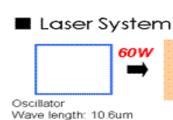


State of Art Gigaphoton LPP Source Configuration\* was Established in 2007 \*several patented

- High ionization rate and CE EUV tin (Sn) plasma generated by dual-wavelength shooting via CO<sub>2</sub> and pre-pulse solid-state lasers
- 2. Hybrid CO<sub>2</sub> laser system with short pulse high repetition rate oscillator and commercial cwamplifiers
- 3. Tin debris mitigation with a super conductive magnetic field
- 4. Accurate shooting control with droplet and laser beam control
- 5. Highly efficient out-of-band light reduction with grating structured C1 mirror



ETS-2 demonstrated at 10W avg. power and 50W power with Magnetic Mitigation.







Pre-Amplifier RF-excited CO2 laser

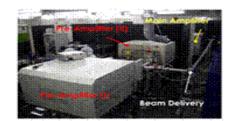


Main-Amplifier RF-excited CO2 laser

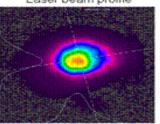


100 W at I/F equivalent

13 kW

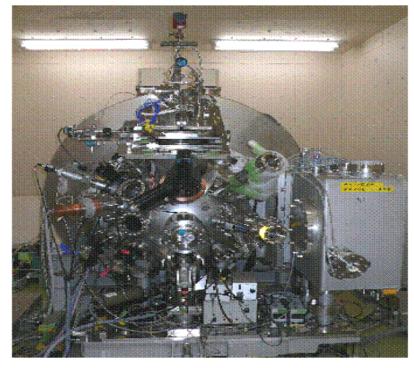


Laser beam profile



	SPIE 2010	<b>EUV Symposium</b>	SPIE2011
	(Feb.2010)	(Oct.2010)	(Feb,2011)
EUV power ( @ I/F)	69 W	104 W	42 W
EUV power ( clean @ I/F)	33 W	50 W	20 W
Duty cycle	20 %	20 %	5%
Max. non stop op. time	>1 hr	<1 hr	>7 hr
Average CE	2.3 %	2.5 %	2.1%
Dose stability :simulation	(+/- 0.15%)		-
Droplet diameter	60μm	<b>60μm</b>	<b>30μm</b>
CO <sub>2</sub> laser power	5.6 kW	7.9 PM	3 ENVI



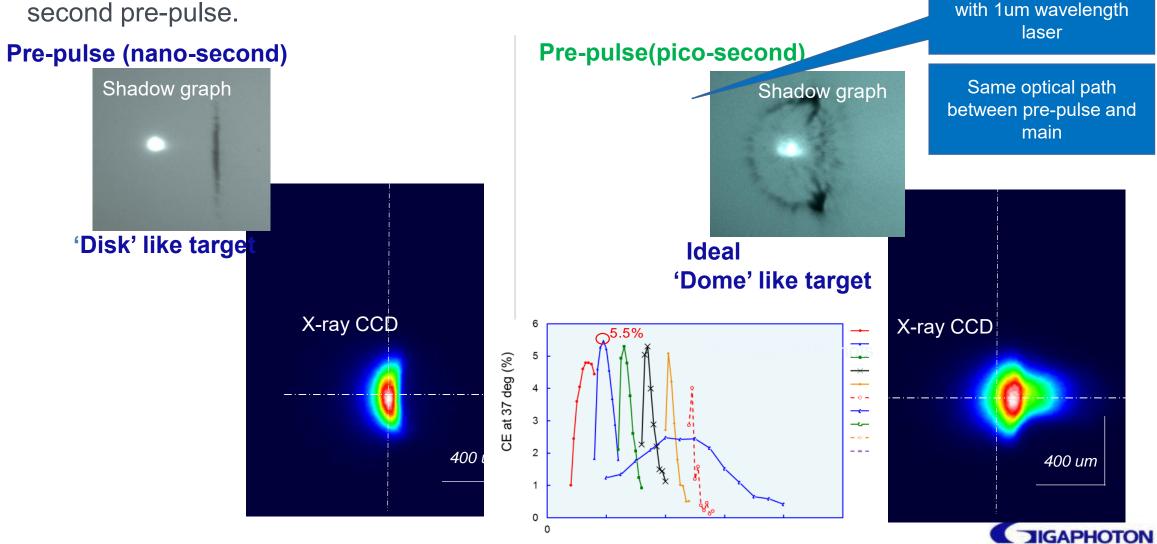




Very short pulse duration

### History of LPP source development 2012

Gigaphoton found >50% advantage of conversion efficiency by picosecond pre-pulse.





■ High power amplifier ETS achieved 20kW peak power.

> CO<sub>2</sub> AMP system experiment is on going in Mitsubishi electric co.



Osc. Unit

Amp. Unit



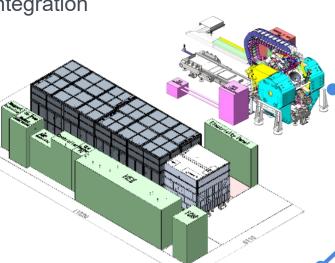
#### **Hiratsuka Center at present**

1F

**Utilities Area** 

Pilot#1
Operational since July 2016

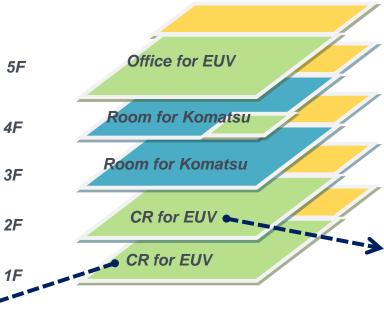
First pilot system designed for NXE integration



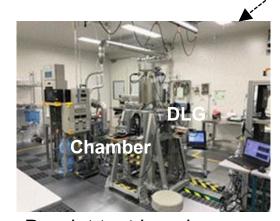
#### Proto#2

**Operational since November 2013** 

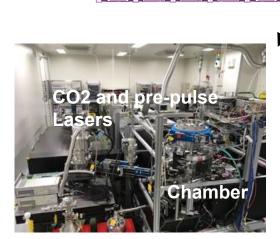
System for key technology development in >100W power level



Hiratsuka center



■ Droplet test bench Reliability, Stability etc.



**2F** 

bench

10Hz EUV

test bench

■ EUV plasma study (<10Hz) CE, ions energy etc.

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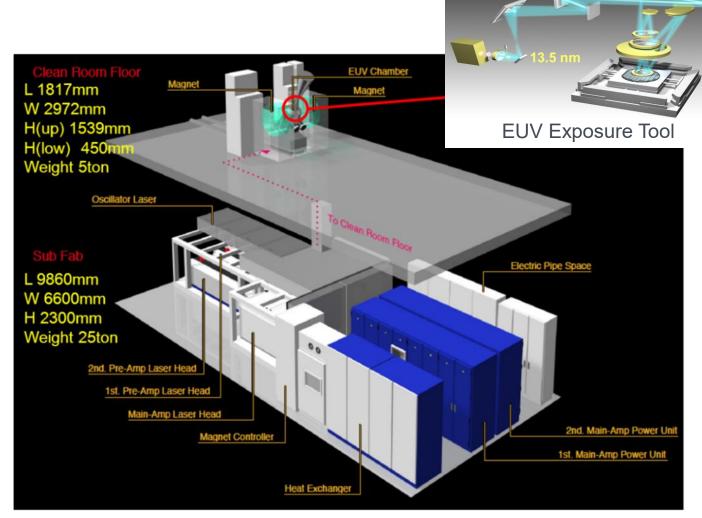


## Layout of >330W EUV Light Source Pilot #1

#### First HVM EUV Source

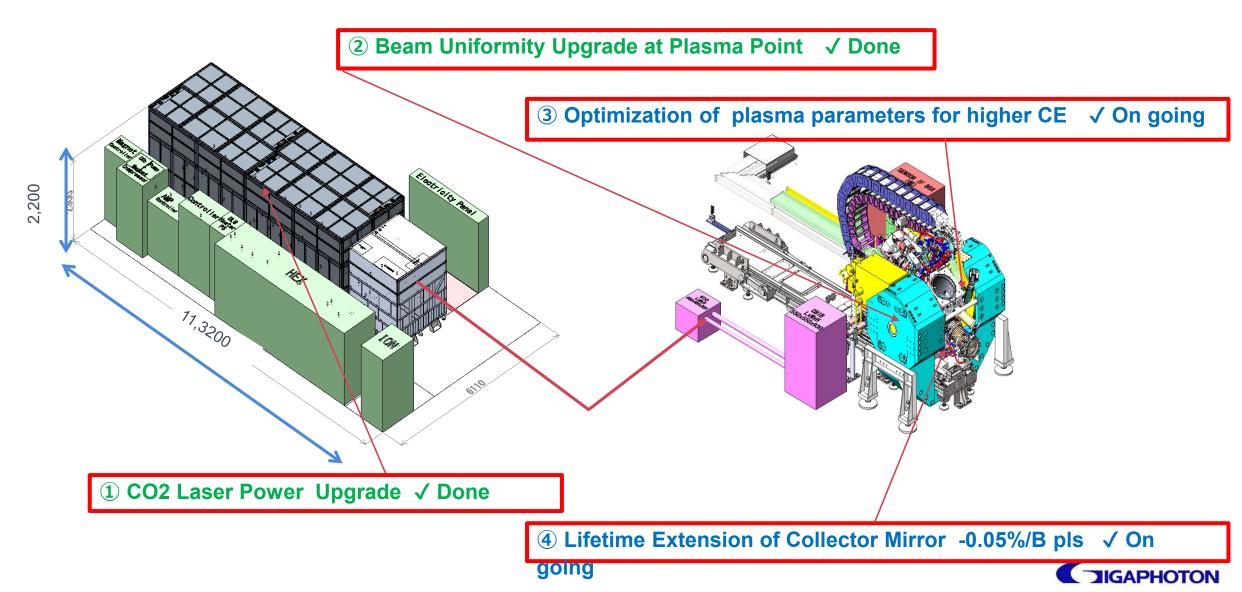
- Original design was 250W EUV source
- >330W Power Challenge with Upgraded Hardware

Operational specification (Target)		HVM Source		
	<b>EUV Power</b>		> 330W	
Perform ance Pulse rate		> 5.5-6.0%		
			100kHz	
	Availability		> 90 %	
Techno logy	Droplet generator	Droplet size	< 20 micron	
	CO2 laser	Power	> 27 kW	
	Pre-pulse laser	Pulse duration	~10 ps pulse duration	
	Debris mitigation	Magnet, Etching	>3 months	



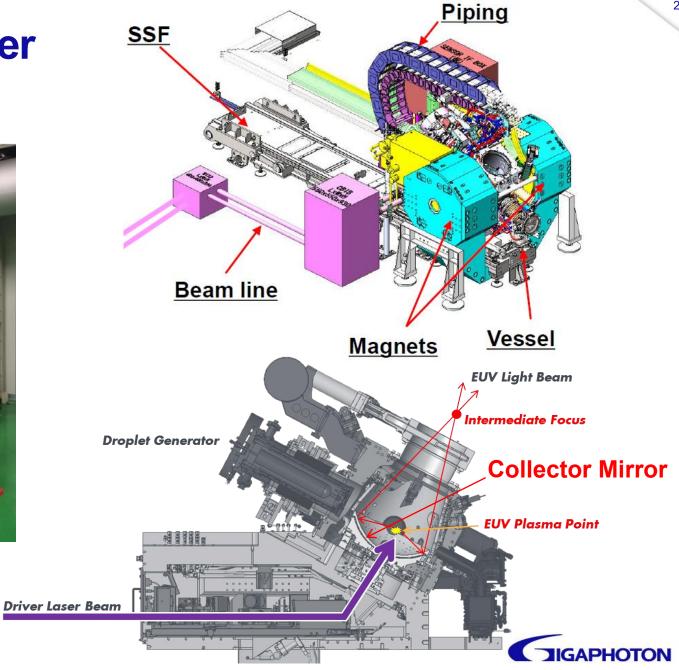


## >330W Power Challenge with Upgraded Hardware



## **Pilot System EUV Chamber**

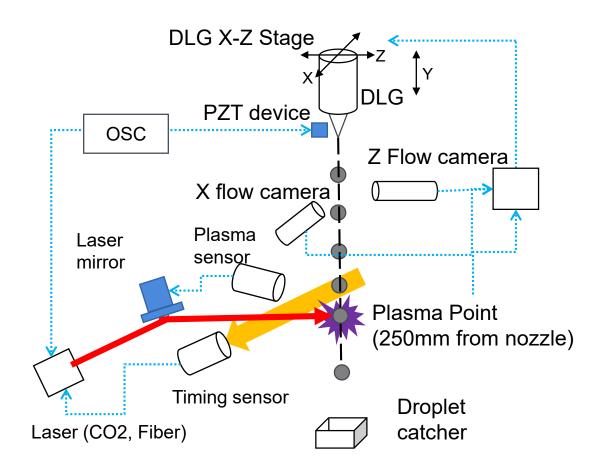




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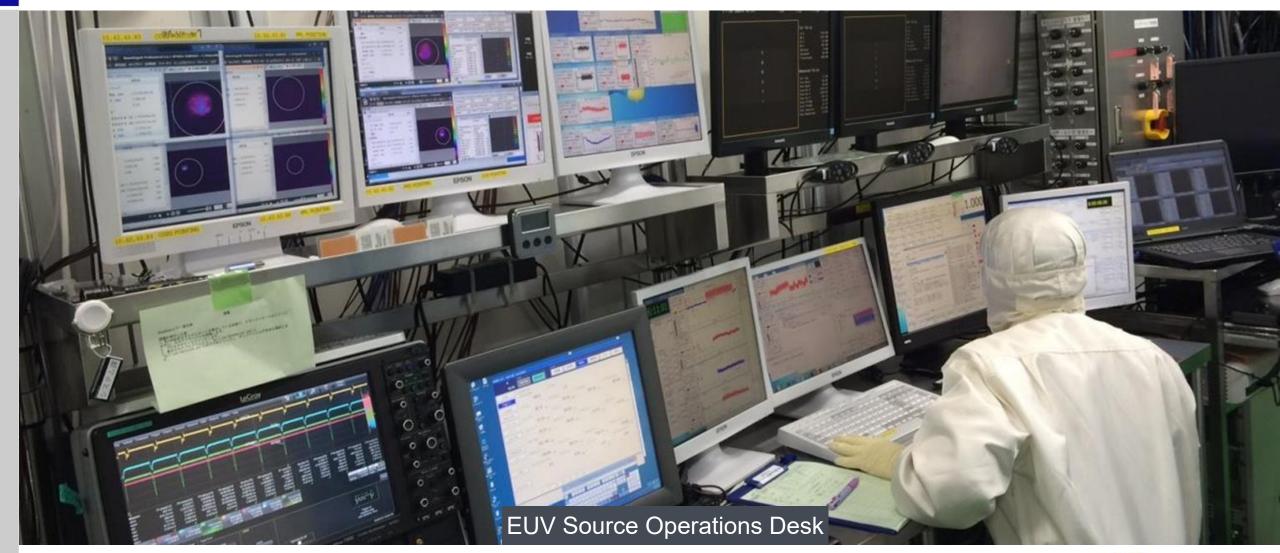
#### **Pilot System Droplet Generator**

**LPP EUV Source Shooting Control System** 





## **Pilot#1 System in Operation**



## >330W Power Challenge with Upgraded Hardware

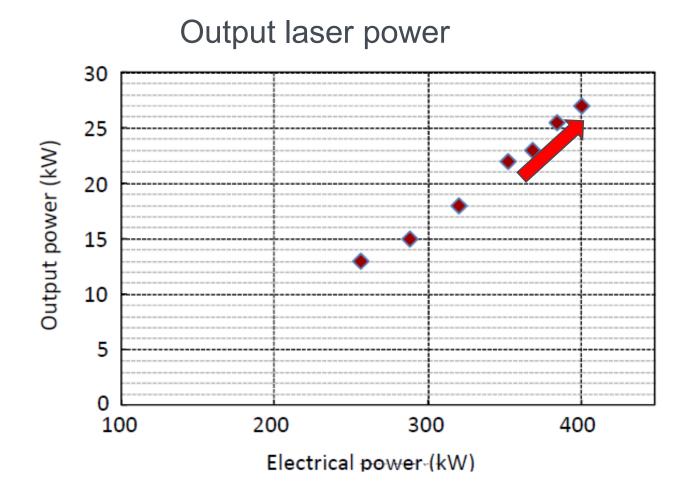
			_
Target	Q4 2018	On Going	Q4 2019
Average Power	125W	250W-330W	≧330W
Repetition rate	100kHz	100kHz	100kHz
CO2 power (energy) at plasma operation with dose ctrl./maximum	10kW/16kW (100mJ/160mJ)	18kW/25kW (180mJ/250mJ)	18kW/25kW (180mJ/250mJ)
CE	4.0%	4.5~5.0%	5.5~6%
Technology for high power			
① CO2 Laser power Upgrade		<b>∨</b>	V
② Beam Uniformity Upgrade at Plasma Point		<b>V</b>	<b>∨</b>
③ Optimization of Plasma Parameters			V
4 Lifetime Extension of Collector Mirror <0.05%/Bpls			V

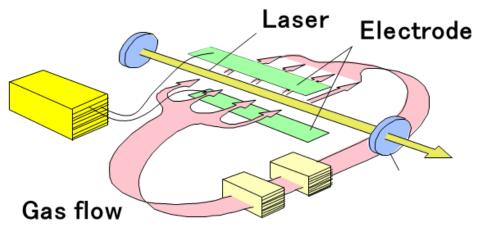


## 1 CO<sub>2</sub> LASER POWER UPGRADE

#### Improvement of Higher-power CO<sub>2</sub> laser

- High-efficient laser amplifier with transvers flow concept (Mitsubishi electric).
- Recent improvement achieved 27 kW laser power operation.





Transverse flow type amplifier





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#### Transverse flow type CO<sub>2</sub> Laser

#### **Benefits**

- Excellent beam uniformity enables efficient EUV creation
- Short maintenance down time
  - Separated optical binding module design
  - Auto beam adjustment
- Efficient CO2 Laser and eco-friendly

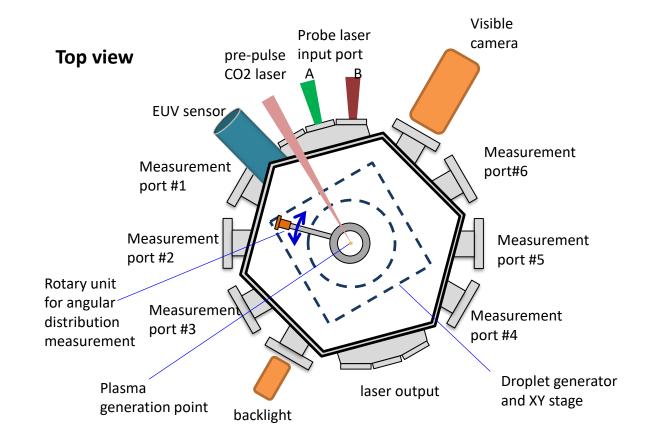
Utility	Spec.		Pilot#1
Input Electricity (full load)	1690 kVA	>	880 kVA
Cooling Water Flow Rate	2221 L/min.	>	1608 L/min.
Hydrogen Flow Rate	600 L/min.	>	360 L/min.
Laser Gas	TBD		351 kL/year

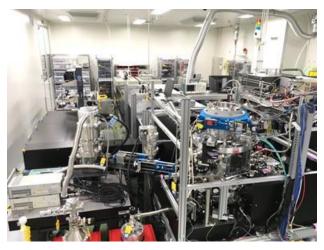
	Conventional	GPI	Remark
Beam profile uniformity	Not uniform	Uniform	Uniform beam profile leads higher CE.
Separate Optical Binding module	N/A	Yes	Minimize chamber replace time
Auto Beam adjustment	N/A	Yes	Keep uniform beam profile without interruption for adjustment
Utility requirement		0	30% less electricity and other utilities

# 2 BEAM UNIFORMITY UPGRADE AT PLASMA POINT

#### Test apparatus for pre-pulse study

- EUV generation at 10Hz
- Studies on CE improvement and debris mitigation
- Measurement tools for EUV radiation and tin particles and plasma characterization





Overview of test apparatus

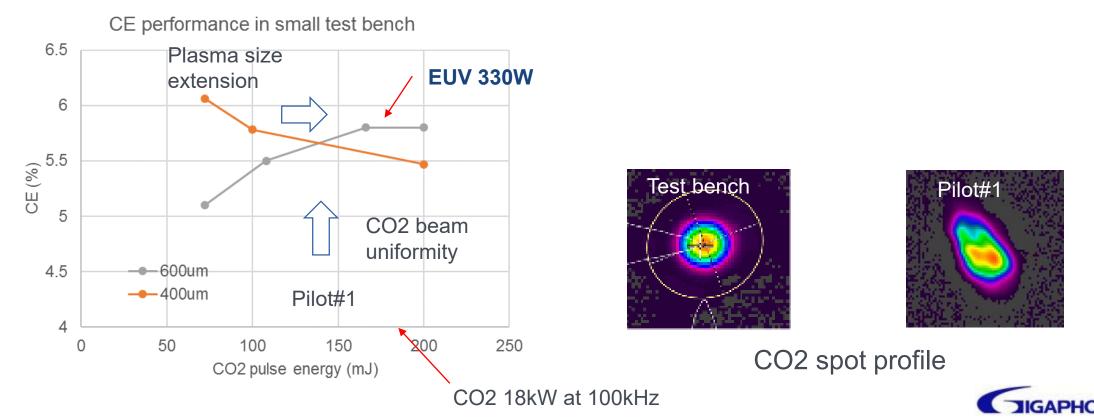
#### **Measurement tools**

- EUV radiation
  - spectrometer
  - imaging camera
- Sn ions
  - -Faraday cup
  - -Electro static analyzer
- Sn atoms
  - -Laser induced fluorescence
- Sn fragments
  - Mie scattering
- Plasma
  - -Thomson scattering



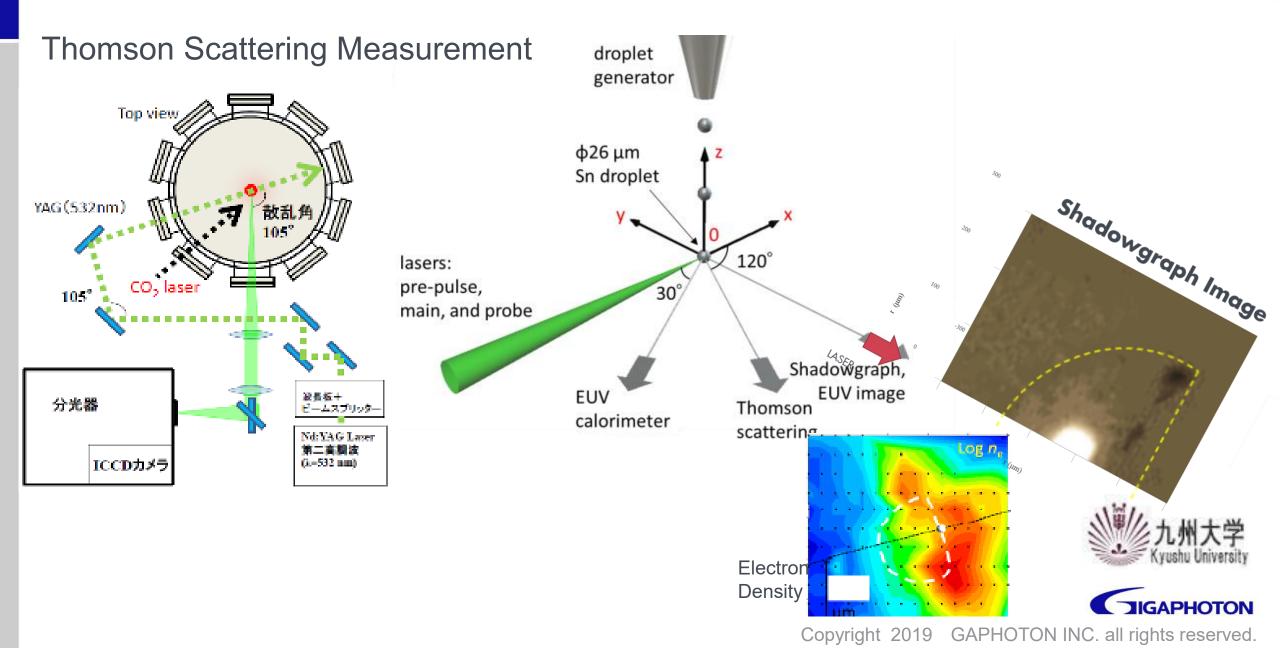
#### **Key Technology for higher CE**

- 5.8% CE at 180mJ was already confirmed in **small test bench** by increased plasma size.
- CO2 beam non-uniformity of Pilot#1 due to beam expander design is improved.

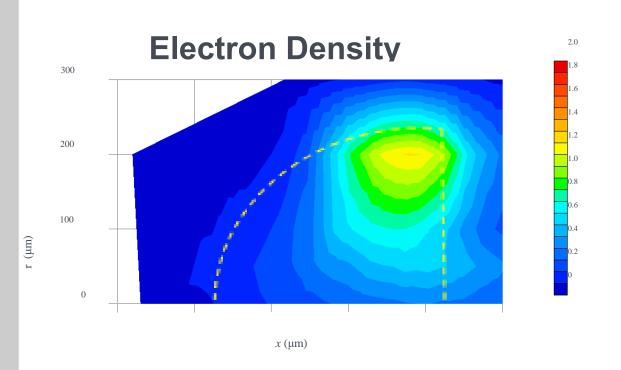


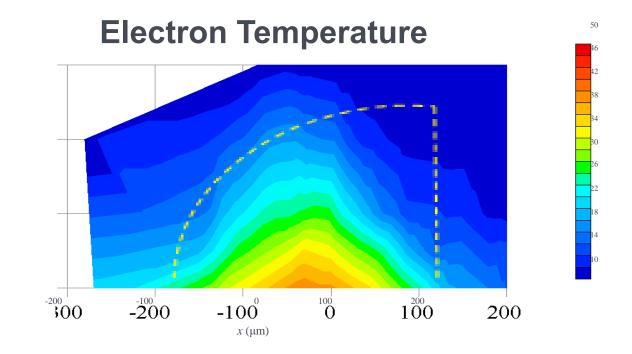
## 3 OPTIMIZATION OF PLASMA PARAMETERS

## Plasma Parameter Measurement (1/2)



## Plasma Parameter Measurement (2/2)





Tomson Scattering measurement characterize pre-pulse plasma in detail!

Next step: CE enhancement by plasma optimization.

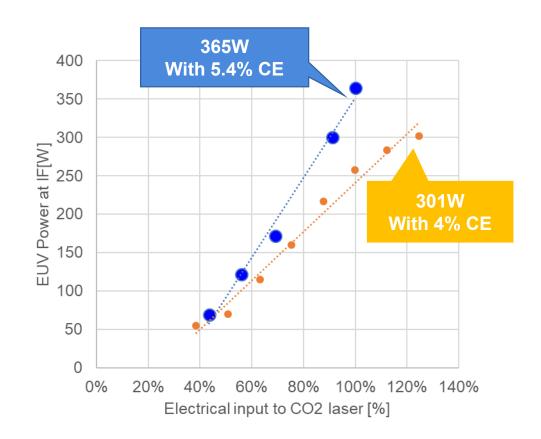


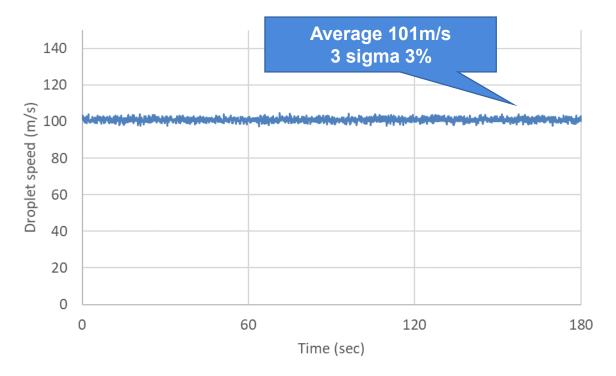


## LATEST SYSTEM OPERATION DATA OF PILOT#1

#### Latest data for higher power

- >360W with >5% CE at 100kHz operation is demonstrated at Pilot#1 (short term)
- Higher Droplet speed(>100m/s)
  realize 1mm spacing and demonstrate
  more stable EUV generation







#### **Agenda**

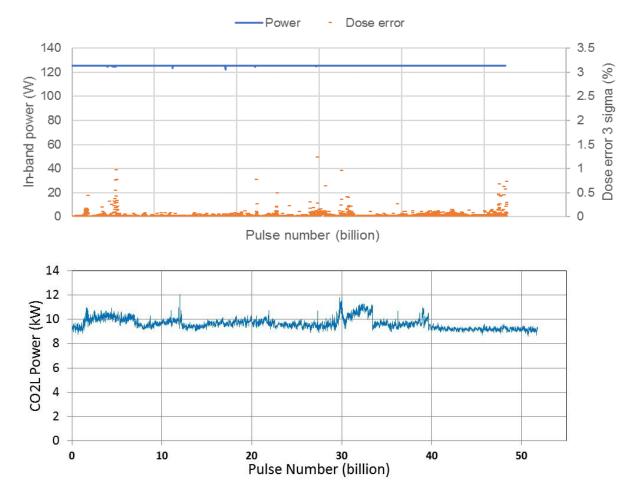
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#### **System Performance: 125W Operation Data**

■ 125W had been achieved with only 10 kW of CO<sub>2</sub> power for 53Bpls operation.

	Performance
Average power at IF	125W
Dose error average (3 sigma)	0.04%
Die yield (<0.16%)	98.5%
Pulse Number	53Bpls
Duty cycle	100%
In-band power	125W
Dose margin	40%
Collector lifetime	0.9%/Bpls
Repetition rate	100kHz

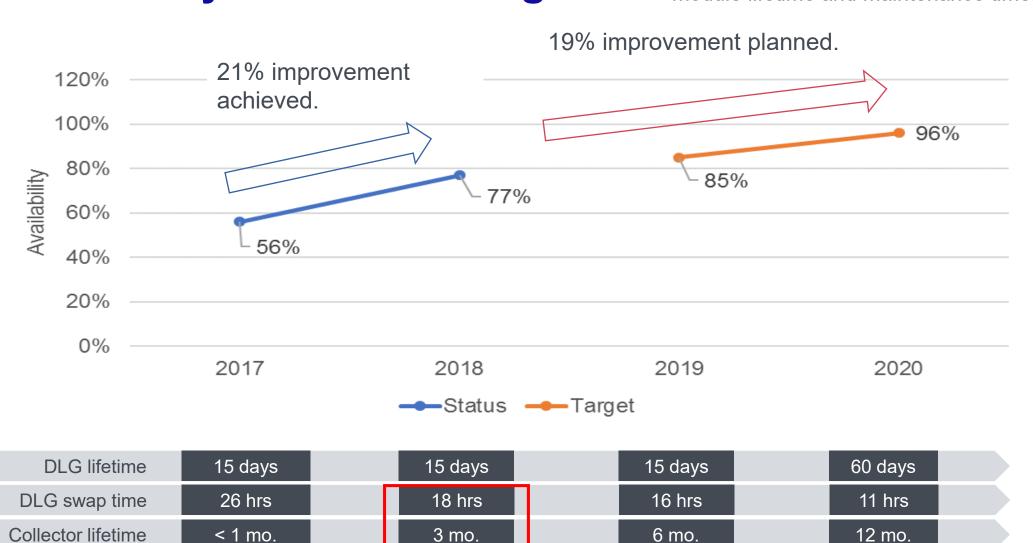


# **Availability: Status and Targets**

58 hrs.

Chamber maintenance

\* Potential availability is calculated, based on module lifetime and maintenance time.

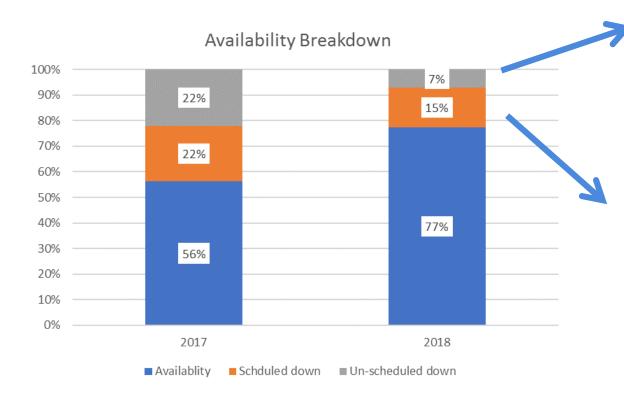


45 hrs.

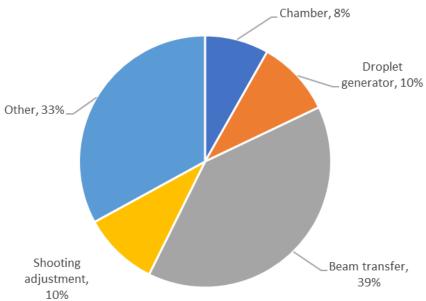
28 hrs.

38 hrs.

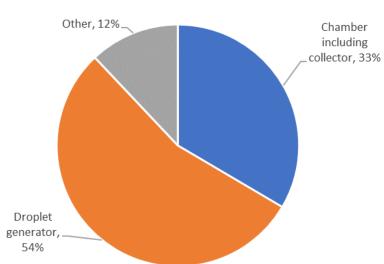
# **Availability: Breakdown**



## Un-scheduled down



#### Scheduled down

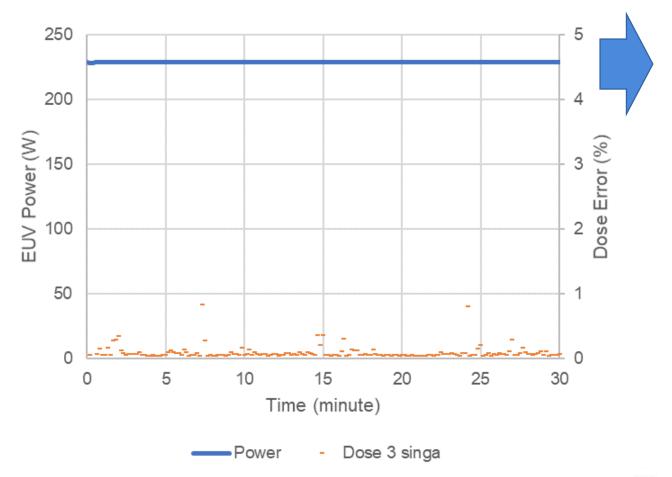




# **Latest 230W Middle-term Operation Data**

■ Closed loop performance of 230W has been just started. (shown data is only 30min however experiment is still continuing).

Performance
230W
0.09%
20%
100kHz

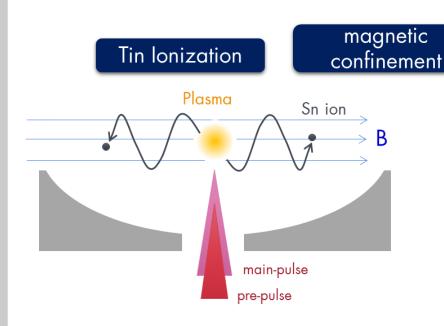




# 4 LIFETIME EXTENSION OF COLLECTOR MIRROR

# **Etching and Dissociation Sn balance on the Mirror Surface**

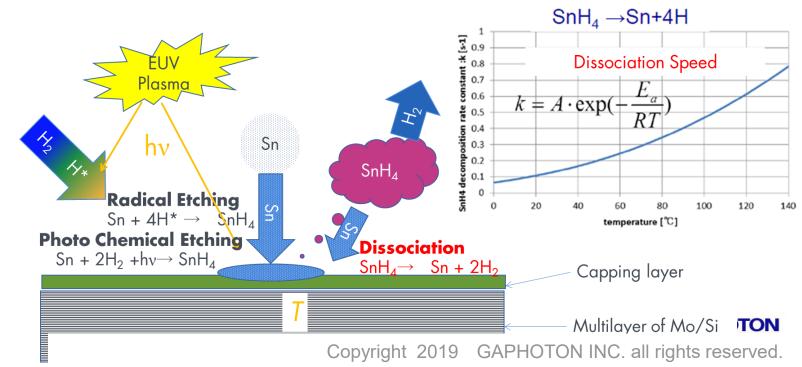
Chemical Aquarium on the Mirror Surface



- Tin ionization & magnetic guiding
  - Tin is ionized effectively by double pulse irradiation
  - Tin ions are confined with magnetic field
  - Confined tin ions are guided and discharged from exhaust ports

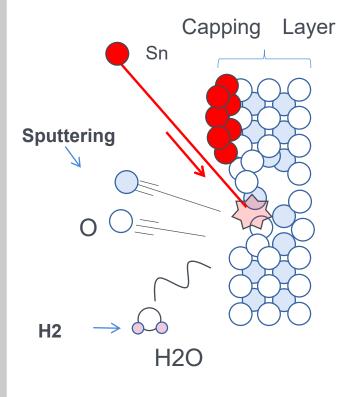
- Protection & cleaning of collector with H<sub>2</sub> gas
  - ► High energy tin neutrals are decelerated by H<sub>2</sub> gas in order to prevent the sputtering of the coating of collector.
  - Deposited tin on the collector is etched by H radical gas\*.
  - Gas flow and cooling systems for preventing decomposition of etched tin (SnH₄)

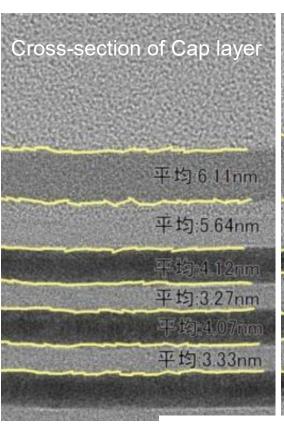
\*H<sub>2</sub> molecules are dissociated to H radical by EUV-UV radiation from plasma.

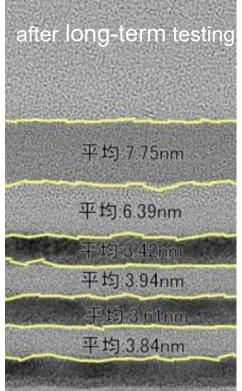


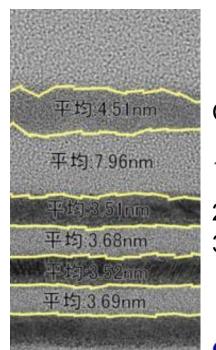
# Change of Capping Layer and Multi-Layer under Tin Plasma Sputtering

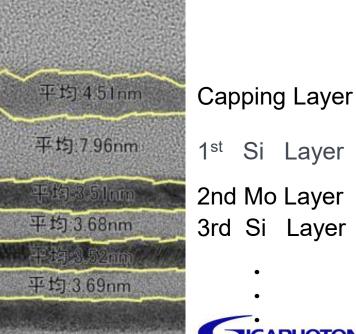
- Thickness changes at capping layer due to sputtering.
- First Si layer become thicker and reflectance down around 30% due to oxidization.





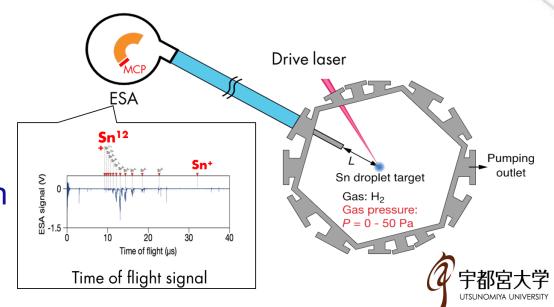


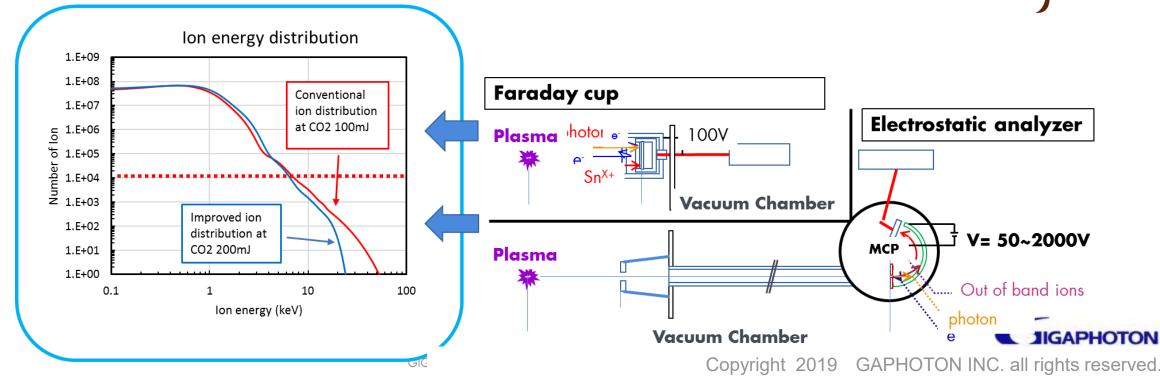




# Suppression of Fast Tin Ion

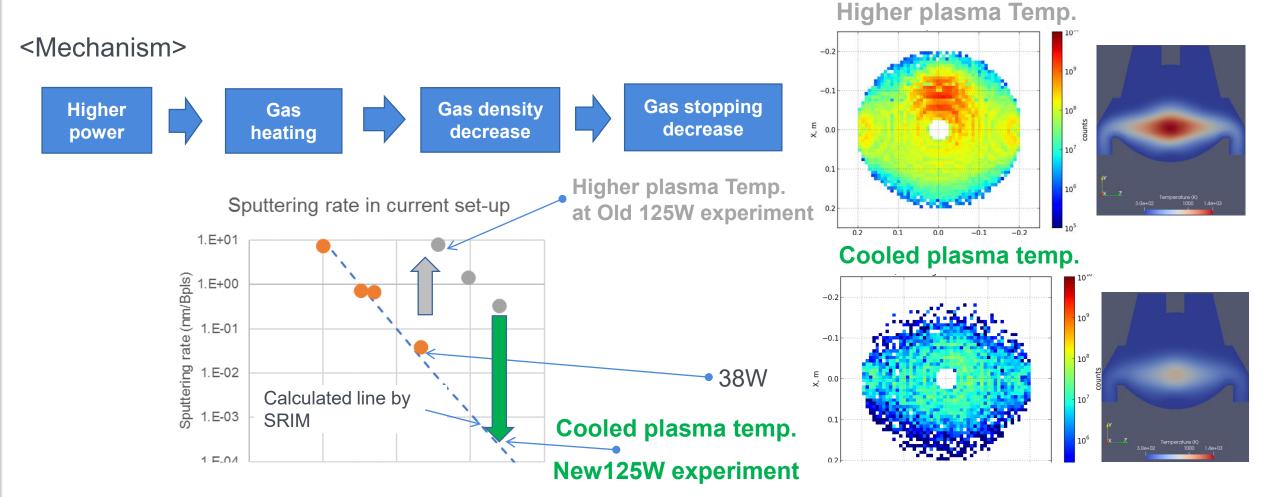
- Ion energy and charge-state measurement with electro-static analyzer(ESA)
- Improvement of Ion energy distribution is essentially effective.





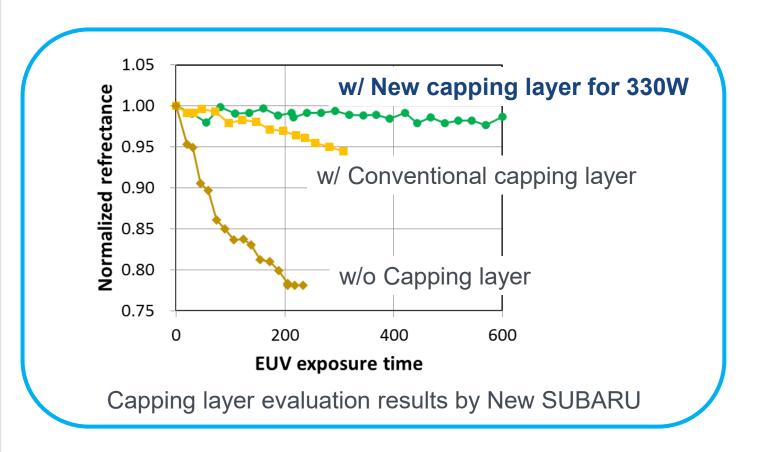
# **EUV Plasma Cooling**

- Sputtering rate enhancement occurred by gas heating at higher output power.
- **EUV plasma cooling** is key of mirror lifetime extension at higher power operation.



### New Capping Layer Search at New SUBARU Japan

- Screening of oxidation of reflection layer with synchrotron radiation (λ=13.5nm) source (Name of SOR in Hyogo Univ.= "New SUBARU")
- Improvement of collector lifetime is on going





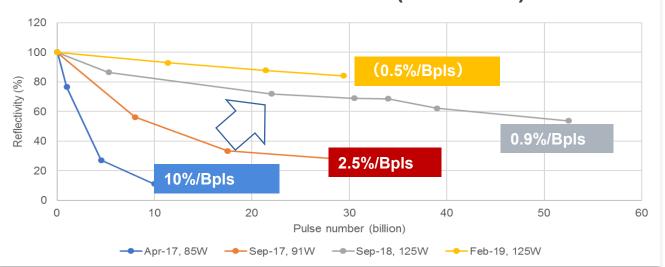
Two beam lines for EUV test in "New SUBARU"



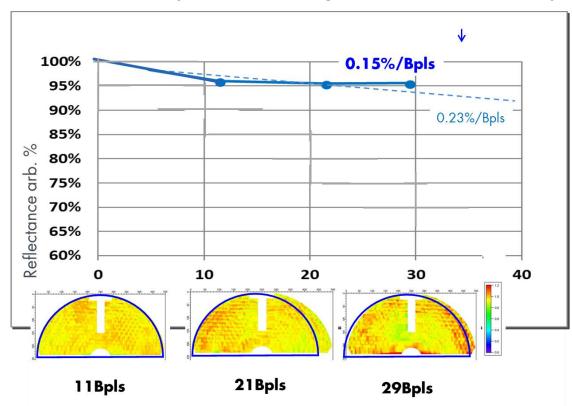
### **Collector Mirror: Lifetime Status**

- Capping layer and Tin contained Gas flow Improvement are effective.
- Collector reflectivity degradation is certainly improving.

#### **Data at SPIE AL-2019 (Feb.2019)**



#### Latest Data (125W level operation; June 2019)





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# **Summary**

- EXPERIMENT-A: >330W Power Challenge of EUV Source
  - ► Gigaphoton redefined power target to ≥330W ave. with -0.05%/Gpls, >90% availability
  - ► High conversion efficiency 5.0% is realized with improved driver laser technology.
  - ► High speed (>100m/s) & small (20micron) droplet successfully stabilize EUV emission...
  - ► CE enhancement >6% by plasma parameter optimization is clarified through small experimental device by Tomson scattering measurement.
  - ► CO2 laser power upgrade >27kW and Beam uniformity upgrade is successfully done.
  - > >350W operation is successfully demonstrated at Pilot#1 system (short term).
- EXPERIMENT-B: Long-term Test and Challenge for Long-life Mirror and Availability
  - ► 125W had been achieved with only 10 kW of CO2 power for around 50Bpls operation.
  - ► Pilot#1 system achieved potential of >85% Availability (2weeks average).
  - ► -0.15%/Gpls with 125W ave. was demonstrated during 30Mpls with mirror test.
  - > 230W operation is just started to prove durability of high power EUV source.
- Demonstration of Full Spec. >330W operation will be by Q4 2019



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# THANK YOU



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